

PCN Number:	20180118003	PCN Date:	February 5, 2018
Title:	Datasheet for TPA3221		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



TPA3221

SLASEE9B – SEPTEMBER 2017 – REVISED DECEMBER 2017

Changes from Revision A (November 2017) to Revision B

Page

• Changed OUT_P To: OUT1_P for 1 x BTL in Table 1	4
• Added pins OSCM, OSCP to the Interface pins in the <i>Absolute Maximun Ratings</i> table.....	5
• Changed the T _J MIN value From: 0°C To –40°C in the <i>Absolute Maximun Ratings</i> table	5
• Deleted T _J Junction Temperature from the <i>Recommended Operating Conditions</i> table	5
• Changed the capacitor on IN1_P, IN2_P and IN1_M, IN2_M From: 10µF To: 1µF in Figure 50	30
• Changed the capacitor on IN1_P and IN1_M From: 10µF To: 1µF in Figure 51	32
• Changed the capacitor on IN1_P and IN1_M From: 10µF To: 1µF in Figure 52	33

The datasheet number will be changing.

Device Family	Change From:	Change To:
TPA3221	SLASEE9A	SLASEE9B

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/TPA3221>

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

TPA3221DDV	TPA3221DDVR		
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For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com